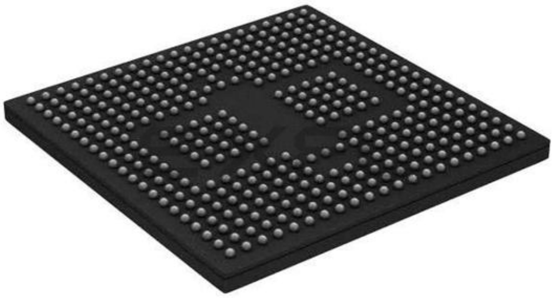

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	XCore
Core Size	32-Bit 32-Core
Speed	4000MIPS
Connectivity	USB
Peripherals	-
Number of I/O	208
Program Memory Size	-
Program Memory Type	ROMless
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	0.95V ~ 3.6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	374-LFBGA
Supplier Device Package	374-FBGA (18x18)
Purchase URL	https://www.e-xfl.com/product-detail/xmos/xu232-512-fb374-c40

Table of Contents

1 xCORE Multicore Microcontrollers

The xCORE200 Series is a comprehensive range of 32-bit multicore microcontrollers that brings the low latency and timing determinism of the xCORE architecture to mainstream embedded applications. Unlike conventional microcontrollers, xCORE multicore microcontrollers execute multiple real-time tasks simultaneously and communicate between tasks using a high speed network. Because xCORE multicore microcontrollers are completely deterministic, you can write software to implement functions that traditionally require dedicated hardware.

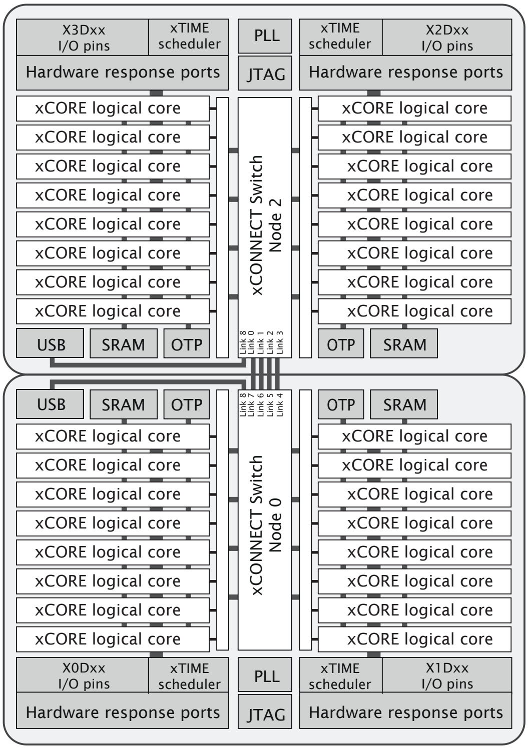

Figure 1: XU232-512-FB374 block diagram

Key features of the XU232-512-FB374 include:

- **Tiles**: Devices consist of one or more xCORE tiles. Each tile contains between five and eight 32-bit xCOREs with highly integrated I/O and on-chip memory.
- **Logical cores** Each logical core can execute tasks such as computational code, DSP code, control software (including logic decisions and executing a state machine) or software that handles I/O. Section 6.1
- **xTIME scheduler** The xTIME scheduler performs functions similar to an RTOS, in hardware. It services and synchronizes events in a core, so there is no requirement for interrupt handler routines. The xTIME scheduler triggers cores

2 XU232-512-FB374 Features

- **Multicore Microcontroller with Advanced Multi-Core RISC Architecture**
  - 32 real-time logical cores on 4 xCORE tiles
  - Cores share up to 2000 MIPS
    — Up to 4000 MIPS in dual issue mode
  - Each logical core has:
    — Guaranteed throughput of between 1/5 and 1/8 of tile MIPS
    — 16x32bit dedicated registers
  - 167 high-density 16/32-bit instructions
    — All have single clock-cycle execution (except for divide)
    — 32x32→64-bit MAC instructions for DSP, arithmetic and user-definable cryptographic functions
- **Dual USB PHY, fully compliant with USB 2.0 specification**
- **Programmable I/O**
  - 176 general-purpose I/O pins, configurable as input or output
    — Up to 56 x 1bit port, 22 x 4bit port, 13 x 8bit port, 6 x 16bit port, 4 x 32bit port
    — 8 xCONNECT links
  - Port sampling rates of up to 60 MHz with respect to an external clock
  - 128 channel ends (32 per tile) for communication with other cores, on or off-chip
- **Memory**
  - 512KB internal single-cycle SRAM (max 128KB per tile) for code and data storage
  - 32KB internal OTP (max 8KB per tile) for application boot code
- **Hardware resources**
  - 24 clock blocks (6 per tile)
  - 40 timers (10 per tile)
  - 16 locks (4 per tile)
- **JTAG Module for On-Chip Debug**
- **Security Features**
  - Programming lock disables debug and prevents read-back of memory contents
  - AES bootloader ensures secrecy of IP held on external flash memory
- **Ambient Temperature Range**
  - Commercial qualification: 0 °C to 70 °C
  - Industrial qualification: -40 °C to 85 °C
- **Speed Grade**
  - 40: 2000 MIPS
- **Power Consumption**
  - 1140 mA (typical)
- **374-pin FBGA package 0.8 mm pitch**

5 Example Application Diagram

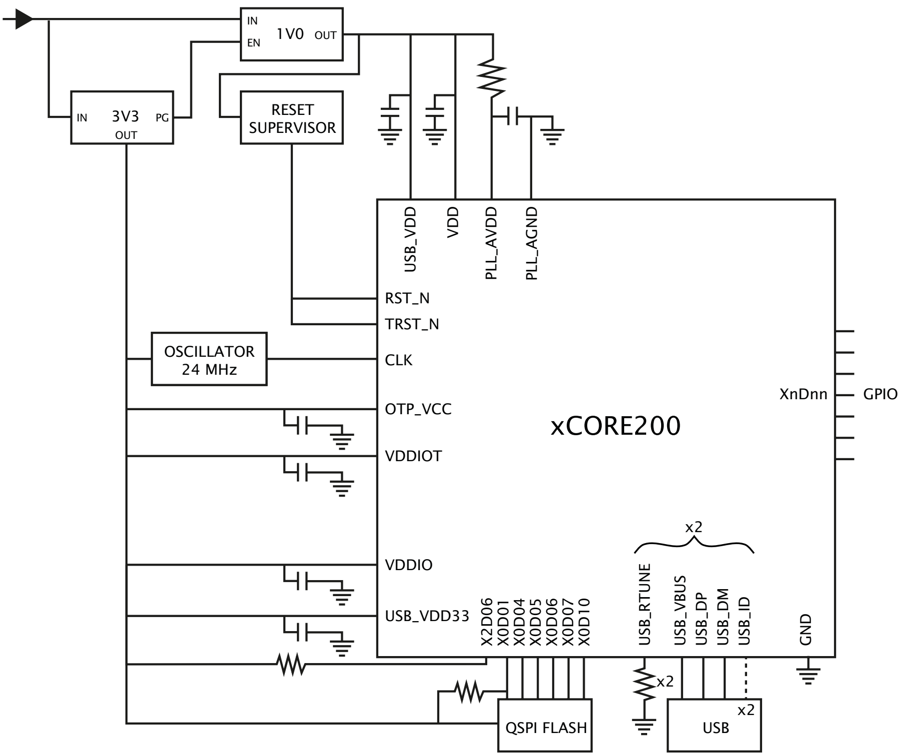

Figure 2: Simplified Reference Schematic

- see Section 10 for details on the USB PHY
- see Section 12 for details on the power supplies and PCB design

6 Product Overview

The XU232-512-FB374 is a powerful device that consists of four xCORE Tiles, each comprising a flexible logical processing cores with tightly integrated I/O and on-chip memory.

6.1 Logical cores

Each tile has 8 active logical cores, which issue instructions down a shared five-stage pipeline. Instructions from the active cores are issued round-robin. If up to five logical cores are active, each core is allocated a fifth of the processing cycles. If more than five logical cores are active, each core is allocated at least $1/n$ cycles (for n cores). Figure 3 shows the guaranteed core performance depending on the number of cores used.

Figure 3: Logical core performance

Speed grade	MIPS	Frequency	Minimum MIPS per core (for *n* cores)							
			1	2	3	4	5	6	7	8
20	2000 MIPS	500 MHz	100	100	100	100	100	83	71	63

There is no way that the performance of a logical core can be reduced below these predicted levels (unless *priority threads* are used: in this case the guaranteed minimum performance is computed based on the number of priority threads as defined in the architecture manual). Because cores may be delayed on I/O, however, their unused processing cycles can be taken by other cores. This means that for more than five logical cores, the performance of each core is often higher than the predicted minimum but cannot be guaranteed.

The logical cores are triggered by events instead of interrupts and run to completion. A logical core can be paused to wait for an event.

6.2 xTIME scheduler

The xTIME scheduler handles the events generated by xCORE Tile resources, such as channel ends, timers and I/O pins. It ensures that all events are serviced and synchronized, without the need for an RTOS. Events that occur at the I/O pins are handled by the Hardware-Response ports and fed directly to the appropriate xCORE Tile. An xCORE Tile can also choose to wait for a specified time to elapse, or for data to become available on a channel.

Tasks do not need to be prioritised as each of them runs on their own logical xCORE. It is possible to share a set of low priority tasks on a single core using cooperative multitasking.

6.3 Hardware Response Ports

Hardware Response ports connect an xCORE tile to one or more physical pins and as such define the interface between hardware attached to the XU232-512-FB374, and the software running on it. A combination of 1bit, 4bit, 8bit, 16bit and 32bit ports are available. All pins of a port provide either output or input. Signals in different directions cannot be mapped onto the same port.

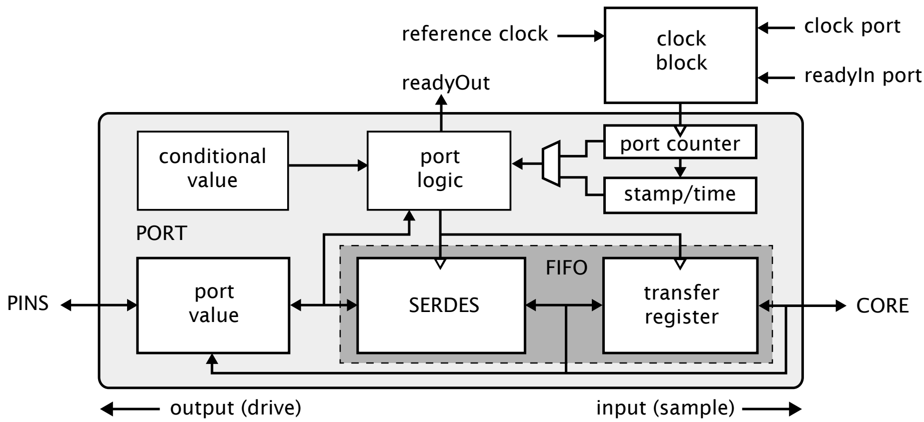

Figure 4: Port block diagram

The port logic can drive its pins high or low, or it can sample the value on its pins, optionally waiting for a particular condition. Ports are accessed using dedicated instructions that are executed in a single processor cycle. xCORE-200 IO pins can be used as *open collector* outputs, where signals are driven low if a zero is output, but left high impedance if a one is output. This option is set on a per-port basis.

Data is transferred between the pins and core using a FIFO that comprises a SERDES and transfer register, providing options for serialization and buffered data.

Each port has a 16-bit counter that can be used to control the time at which data is transferred between the port value and transfer register. The counter values can be obtained at any time to find out when data was obtained, or used to delay I/O until some time in the future. The port counter value is automatically saved as a timestamp, that can be used to provide precise control of response times.

The ports and xCONNECT links are multiplexed onto the physical pins. If an xConnect Link is enabled, the pins of the underlying ports are disabled. If a port is enabled, it overrules ports with higher widths that share the same pins. The pins on the wider port that are not shared remain available for use when the narrower port is enabled. Ports always operate at their specified width, even if they share pins with another port.

6.4 Clock blocks

xCORE devices include a set of programmable clocks called clock blocks that can be used to govern the rate at which ports execute. Each xCORE tile has six clock blocks: the first clock block provides the tile reference clock and runs at a default frequency of 100MHz; the remaining clock blocks can be set to run at different frequencies.

The pins used for QSPI boot are hardcoded in the boot ROM and cannot be changed. If required, an QSPI boot program can be burned into OTP that uses different pins.

8.2 Boot from SPI master

If set to boot from SPI master, the processor enables the four pins specified in Figure 11, and drives the SPI clock at 2.5 MHz (assuming a 400 MHz core clock). A READ command is issued with a 24-bit address 0x000000. The clock polarity and phase are 0 / 0.

Figure 11: SPI master pins

Pin	Signal	Description
X0D00	MISO	Master In Slave Out (Data)
X0D01	SS	Slave Select
X0D10	SCLK	Clock
X0D11	MOSI	Master Out Slave In (Data)

The xCORE Tile expects each byte to be transferred with the *least-significant bit first*. Programmers who write bytes into an SPI interface using the most significant bit first may have to reverse the bits in each byte of the image stored in the SPI device.

If a large boot image is to be read in, it is faster to first load a small boot-loader that reads the large image using a faster SPI clock, for example 50 MHz or as fast as the flash device supports.

The pins used for SPI boot are hardcoded in the boot ROM and cannot be changed. If required, an SPI boot program can be burned into OTP that uses different pins.

8.3 Boot from SPI slave

If set to boot from SPI slave, the processor enables the three pins specified in Figure 12 and expects a boot image to be clocked in. The supported clock polarity and phase are 0/0 and 1/1.

Figure 12: SPI slave pins

Pin	Signal	Description
X0D00	SS	Slave Select
X0D10	SCLK	Clock
X0D11	MOSI	Master Out Slave In (Data)

The xCORE Tile expects each byte to be transferred with the *least-significant bit first*. The pins used for SPI boot are hardcoded in the boot ROM and cannot be changed. If required, an SPI boot program can be burned into OTP that uses different pins.

8.4 Boot from xConnect Link

If set to boot from an xConnect Link, the processor enables its link(s) around 2 us after the boot process starts. Enabling the Link switches off the pull-down

Feature	Bit	Description
Disable JTAG	0	The JTAG interface is disabled, making it impossible for the tile state or memory content to be accessed via the JTAG interface.
Disable Link access	1	Other tiles are forbidden access to the processor state via the system switch. Disabling both JTAG and Link access transforms an xCORE Tile into a "secure island" with other tiles free for non-secure user application code.
Secure Boot	5	The xCORE Tile is forced to boot from address 0 of the OTP, allowing the xCORE Tile boot ROM to be bypassed (*see* §8).
Redundant rows	7	Enables redundant rows in OTP.
Sector Lock 0	8	Disable programming of OTP sector 0.
Sector Lock 1	9	Disable programming of OTP sector 1.
Sector Lock 2	10	Disable programming of OTP sector 2.
Sector Lock 3	11	Disable programming of OTP sector 3.
OTP Master Lock	12	Disable OTP programming completely: disables updates to all sectors and security register.
Disable JTAG-OTP	13	Disable all (read & write) access from the JTAG interface to this OTP.
Disable Global Debug	14	Disables access to the DEBUG_N pin.
	21..15	General purpose software accessable security register available to end-users.
	31..22	General purpose user programmable JTAG UserID code extension.

Figure 13: Security register features

data in four sectors each containing 512 rows of 32 bits which can be used to implement secure bootloaders and store encryption keys. Data for the security register is loaded from the OTP on power up. All additional data in OTP is copied from the OTP to SRAM and executed first on the processor.

The OTP memory is programmed using three special I/O ports: the OTP address port is a 16-bit port with resource ID 0x100200, the OTP data is written via a 32-bit port with resource ID 0x200100, and the OTP control is on a 16-bit port with ID 0x100300. Programming is performed through `libotp` and `xburn`.

9.2 SRAM

Each xCORE Tile integrates a single 128KB SRAM bank for both instructions and data. All internal memory is 32 bits wide, and instructions are either 16-bit or 32-bit. Byte (8-bit), half-word (16-bit) or word (32-bit) accesses are supported and are executed within one tile clock cycle. There is no dedicated external memory interface, although data memory can be expanded through appropriate use of the ports.

11 JTAG

The JTAG module can be used for loading programs, boundary scan testing, in-circuit source-level debugging and programming the OTP memory.

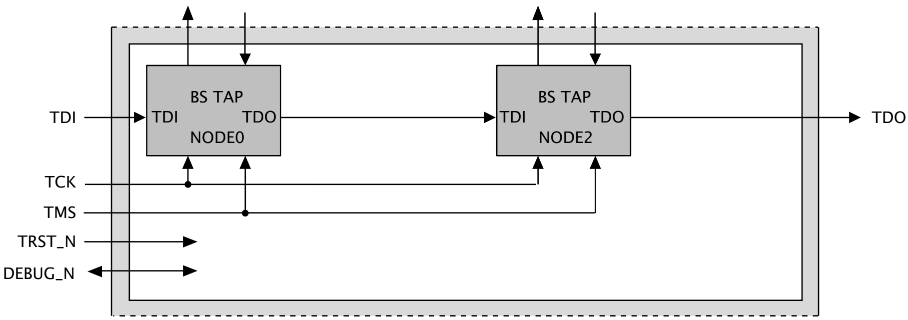

Figure 15: JTAG chain structure

The JTAG chain structure is illustrated in Figure 15. It comprises two 1149.1 compliant TAPs that can be used for boundary scan of the I/O pins. Each tap has a 4-bit IR and 32-bit DR. It also provides access to a chip TAP that in turn can access the xCORE Tile for loading code and debugging.

The TRST_N pin must be asserted low during and after power up for 100 ns. If JTAG is not required, the TRST_N pin can be tied to ground to hold the JTAG module in reset.

The DEBUG_N pin is used to synchronize the debugging of multiple xCORE Tiles. This pin can operate in both output and input mode. In output mode and when configured to do so, DEBUG_N is driven low by the device when the processor hits a debug break point. Prior to this point the pin will be tri-stated. In input mode and when configured to do so, driving this pin low will put the xCORE Tile into debug mode. Software can set the behavior of the xCORE Tile based on this pin. This pin should have an external pull up of 4K7-47K Ω or left not connected in single core applications.

The JTAG device identification register can be read by using the IDCODE instruction. Its contents are specified in Figure 16.

Figure 16: IDCODE return value

<table>
<tr><td colspan="4">Bit31</td><td colspan="24">Device Identification Register</td><td colspan="4">Bit0</td></tr>
<tr><td colspan="4">Version</td><td colspan="16">Part Number</td><td colspan="11">Manufacturer Identity</td><td>1</td></tr>
<tr><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>0</td><td>1</td><td>1</td><td>0</td><td>0</td><td>1</td><td>1</td><td>0</td><td>0</td><td>0</td><td>1</td><td>1</td><td>0</td><td>0</td><td>1</td><td>1</td></tr>
<tr><td colspan="4">0</td><td colspan="4">0</td><td colspan="4">0</td><td colspan="4">0</td><td colspan="4">6</td><td colspan="4">6</td><td colspan="4">3</td><td colspan="4">3</td></tr>
</table>

B.5 Security configuration: 0x05

Copy of the security register as read from OTP.

0x05: Security configuration

Bits	Perm	Init	Description
31	RW		Disables write permission on this register
30:15	RO	-	Reserved
14	RW		Disable access to XCore's global debug
13	RO	-	Reserved
12	RW		lock all OTP sectors
11:8	RW		lock bit for each OTP sector
7	RW		Enable OTP reduanacy
6	RO	-	Reserved
5	RW		Override boot mode and read boot image from OTP
4	RW		Disable JTAG access to the PLL/BOOT configuration registers
3:1	RO	-	Reserved
0	RW		Disable access to XCore's JTAG debug TAP

B.6 Ring Oscillator Control: 0x06

There are four free-running oscillators that clock four counters. The oscillators can be started and stopped using this register. The counters should only be read when the ring oscillator has been stopped for at least 10 core clock cycles (this can be achieved by inserting two nop instructions between the SETPS and GETPS). The counter values can be read using four subsequent registers. The ring oscillators are asynchronous to the xCORE tile clock and can be used as a source of random bits.

0x06: Ring Oscillator Control

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RW	0	Core ring oscillator enable.
0	RW	0	Peripheral ring oscillator enable.

B.7 Ring Oscillator Value: 0x07

This register contains the current count of the xCORE Tile Cell ring oscillator. This value is not reset on a system reset.

0x9C .. 0x9F: Resources breakpoint control register

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	DRW	0	A bit for each thread in the machine allowing the breakpoint to be enabled individually for each thread.
15:2	RO	-	Reserved
1	DRW	0	When 0 break when condition A is met. When 1 = break when condition B is met.
0	DRW	0	When 1 the instruction breakpoint is enabled.

0x00: Device identification

Bits	Perm	Init	Description
31:24	CRO		Processor ID of this XCore.
23:16	CRO		Number of the node in which this XCore is located.
15:8	CRO		XCore revision.
7:0	CRO		XCore version.

C.2 xCORE Tile description 1: 0x01

This register describes the number of logical cores, synchronisers, locks and channel ends available on this xCORE tile.

0x01: xCORE Tile description 1

Bits	Perm	Init	Description
31:24	CRO		Number of channel ends.
23:16	CRO		Number of the locks.
15:8	CRO		Number of synchronisers.
7:0	RO	-	Reserved

C.3 xCORE Tile description 2: 0x02

This register describes the number of timers and clock blocks available on this xCORE tile.

0x02: xCORE Tile description 2

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:8	CRO		Number of clock blocks.
7:0	CRO		Number of timers.

C.4 Control PSwitch permissions to debug registers: 0x04

This register can be used to control whether the debug registers (marked with permission CRW) are accessible through the tile configuration registers. When this bit is set, write -access to those registers is disabled, preventing debugging of the xCORE tile over the interconnect.

0x07: Security configuration

Bits	Perm	Init	Description
31	CRO		Disables write permission on this register
30:15	RO	-	Reserved
14	CRO		Disable access to XCore's global debug
13	RO	-	Reserved
12	CRO		lock all OTP sectors
11:8	CRO		lock bit for each OTP sector
7	CRO		Enable OTP reduanacy
6	RO	-	Reserved
5	CRO		Override boot mode and read boot image from OTP
4	CRO		Disable JTAG access to the PLL/BOOT configuration registers
3:1	RO	-	Reserved
0	CRO		Disable access to XCore's JTAG debug TAP

C.8 Debug scratch: 0x20 .. 0x27

A set of registers used by the debug ROM to communicate with an external debugger, for example over the switch. This is the same set of registers as the Debug Scratch registers in the processor status.

0x20 .. 0x27: Debug scratch

Bits	Perm	Init	Description
31:0	CRW		Value.

C.9 PC of logical core 0: 0x40

Value of the PC of logical core 0.

0x40: PC of logical core 0

Bits	Perm	Init	Description
31:0	CRO		Value.

C.10 PC of logical core 1: 0x41

Value of the PC of logical core 1.

D.8 System JTAG device ID register: 0x09

0x09: System JTAG device ID register

Bits	Perm	Init	Description
31:28	RO		
27:12	RO		
11:1	RO		
0	RO		

D.9 System USERCODE register: 0x0A

0x0A: System USERCODE register

Bits	Perm	Init	Description
31:18	RO		JTAG USERCODE value programmed into OTP SR
17:0	RO		metal fixable ID code

D.10 Directions 0-7: 0x0C

This register contains eight directions, for packets with a mismatch in bits 7..0 of the node-identifier. The direction in which a packet will be routed is goverened by the most significant mismatching bit.

0x0C: Directions 0-7

Bits	Perm	Init	Description
31:28	RW	0	The direction for packets whose dimension is 7.
27:24	RW	0	The direction for packets whose dimension is 6.
23:20	RW	0	The direction for packets whose dimension is 5.
19:16	RW	0	The direction for packets whose dimension is 4.
15:12	RW	0	The direction for packets whose dimension is 3.
11:8	RW	0	The direction for packets whose dimension is 2.
7:4	RW	0	The direction for packets whose dimension is 1.
3:0	RW	0	The direction for packets whose dimension is 0.

D.11 Directions 8-15: 0x0D

This register contains eight directions, for packets with a mismatch in bits 15..8 of the node-identifier. The direction in which a packet will be routed is goverened by the most significant mismatching bit.

0x1F: Debug source

Bits	Perm	Init	Description
31:5	RO	-	Reserved
4	RW		If set, external pin, is the source of last GlobalDebug event.
3:2	RO	-	Reserved
1	RW		If set, XCore1 is the source of last GlobalDebug event.
0	RW		If set, XCore0 is the source of last GlobalDebug event.

D.15 Link status, direction, and network: 0x20 .. 0x28

These registers contain status information for low level debugging (read-only), the network number that each link belongs to, and the direction that each link is part of. The registers control links 0..7.

0x20 .. 0x28: Link status, direction, and network

Bits	Perm	Init	Description
31:26	RO	-	Reserved
25:24	RO		Identify the SRC_TARGET type 0 - SLink, 1 - PLink, 2 - SSCTL, 3 - Undefine.
23:16	RO		When the link is in use, this is the destination link number to which all packets are sent.
15:12	RO	-	Reserved
11:8	RW	0	The direction that this link operates in.
7:6	RO	-	Reserved
5:4	RW	0	Determines the network to which this link belongs, reset as 0.
3	RO	-	Reserved
2	RO		1 when the current packet is considered junk and will be thrown away.
1	RO		1 when the dest side of the link is in use.
0	RO		1 when the source side of the link is in use.

D.16 PLink status and network: 0x40 .. 0x47

These registers contain status information and the network number that each processor-link belongs to.

0x40 .. 0x47: PLink status and network

Bits	Perm	Init	Description
31:26	RO	-	Reserved
25:24	RO		Identify the SRC_TARGET type 0 - SLink, 1 - PLink, 2 - SSCTL, 3 - Undefine.
23:16	RO		When the link is in use, this is the destination link number to which all packets are sent.
15:6	RO	-	Reserved
5:4	RW	0	Determines the network to which this link belongs, reset as 0.
3	RO	-	Reserved
2	RO		1 when the current packet is considered junk and will be thrown away.
1	RO		1 when the dest side of the link is in use.
0	RO		1 when the source side of the link is in use.

D.17 Link configuration and initialization: 0x80 .. 0x88

These registers contain configuration and debugging information specific to external links. The link speed and width can be set, the link can be initialized, and the link status can be monitored. The registers control links 0..7.

0x80 .. 0x88: Link configuration and initialization

Bits	Perm	Init	Description
31	RW		Write to this bit with '1' will enable the XLink, writing '0' will disable it. This bit controls the muxing of ports with overlapping xlinks.
30	RW	0	0: operate in 2 wire mode; 1: operate in 5 wire mode
29:28	RO	-	Reserved
27	RO		Rx buffer overflow or illegal token encoding received.
26	RO	0	This end of the xlink has issued credit to allow the remote end to transmit
25	RO	0	This end of the xlink has credit to allow it to transmit.
24	WO		Clear this end of the xlink's credit and issue a HELLO token.
23	WO		Reset the receiver. The next symbol that is detected will be the first symbol in a token.
22	RO	-	Reserved
21:11	RW	0	Specify min. number of idle system clocks between two continuous symbols witin a transmit token -1.
10:0	RW	0	Specify min. number of idle system clocks between two continuous transmit tokens -1.

E.3 Node identifier: 0x05

0x05: Node identifier

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	0	16-bit node identifier. This does not need to be set, and is present for compatibility with XS1-switches.

E.4 System clock frequency: 0x51

0x51: System clock frequency

Bits	Perm	Init	Description
31:7	RO	-	Reserved
6:0	RW	25	Oscillator clock frequency in MHz rounded up to the nearest integer value. Only values between 5 and 100 MHz are valid - writes outside this range are ignored and will be NACKed. This field must be set on start up of the device and any time that the input oscillator clock frequency is changed. It must contain the system clock frequency in MHz rounded up to the nearest integer value.

E.5 Link Control and Status: 0x80

0x80: Link Control and Status

Bits	Perm	Init	Description
31:28	RO	-	Reserved
27	RO		Rx buffer overflow or illegal token encoding received.
26	RO	0	This end of the xlink has issued credit to allow the remote end to transmit
25	RO	0	This end of the xlink has credit to allow it to transmit.
24	WO		Clear this end of the xlink's credit and issue a HELLO token.
23	WO		Reset the receiver. The next symbol that is detected will be the first symbol in a token.
22	RO	-	Reserved
21:11	RW	1	Specify min. number of idle system clocks between two continuous symbols witin a transmit token -1.
10:0	RW	1	Specify min. number of idle system clocks between two continuous transmit tokens -1.

0x2C: UIFM PID

Bits	Perm	Init	Description
31:4	RO	-	Reserved
3:0	RO	0	Value of the last received PID.

F.13 UIFM Endpoint: 0x30

The last endpoint seen

0x30: UIFM Endpoint

Bits	Perm	Init	Description
31:5	RO	-	Reserved
4	RO	0	1 if endpoint contains a valid value.
3:0	RO	0	A copy of the last received endpoint.

F.14 UIFM Endpoint match: 0x34

This register can be used to mark UIFM endpoints as special.

0x34: UIFM Endpoint match

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RW	0	This register contains a bit for each endpoint. If its bit is set, the endpoint will be supplied on the RX port when ORed with 0x10.

F.15 OTG Flags mask: 0x38

0x38: OTG Flags mask

Bits	Perm	Init	Description
31:0	RW	0	Data

F.16 UIFM power signalling: 0x3C

0x3C: UIFM power signalling

Bits	Perm	Init	Description
31:9	RO	-	Reserved
8	RW	0	Valid
7:0	RW	0	Data

H Schematics Design Check List

☑ This section is a checklist for use by schematics designers using the XU232-512-FB374. Each of the following sections contains items to check for each design.

H.1 Power supplies

☐ VDDIO and OTP_VCC supply is within specification before the VDD (core) supply is turned on. Specifically, the VDDIO and OTP_VCC supply is within specification before VDD (core) reaches 0.4V (Section 12).

☐ The VDD (core) supply ramps monotonically (rises constantly) from 0V to its final value (0.95V - 1.05V) within 10ms (Section 12).

☐ The VDD (core) supply is capable of supplying 1400 mA (Section 12 and Figure 21).

☐ PLL_AVDD is filtered with a low pass filter, for example an RC filter, see Section 12 .

H.2 Power supply decoupling

☐ The design has multiple decoupling capacitors per supply, for example at least four0402 or 0603 size surface mount capacitors of 100nF in value, per supply (Section 12).

☐ A bulk decoupling capacitor of at least 10uF is placed on each supply (Section 12).

H.3 Power on reset

☐ The RST_N and TRST_N pins are asserted (low) during or after power up. The device is not used until these resets have taken place.

H.4 Clock

☐ The CLK input pin is supplied with a clock with monotonic rising edges and low jitter.

☐ Pins MODE0 and MODE1 are set to the correct value for the chosen oscillator frequency. The MODE settings are shown in the Oscillator section, Section 7. If you have a choice between two values, choose the value with the highest multiplier ratio since that will boot faster.

J Associated Design Documentation

Document Title	Information	Document Number
Estimating Power Consumption For XS1-U Devices	Power consumption	
Programming XC on XMOS Devices	Timers, ports, clocks, cores and channels	X9577
xTIMEcomposer User Guide	Compilers, assembler and linker/mapper Timing analyzer, xScope, debugger Flash and OTP programming utilities	X3766

K Related Documentation

Document Title	Information	Document Number
The XMOS XS1 Architecture	ISA manual	X7879
XS1 Port I/O Timing	Port timings	X5821
xCONNECT Architecture	Link, switch and system information	X4249
XS1-U Link Performance and Design Guidelines	Link timings	
XS1-U Clock Frequency Control	Advanced clock control	